## Government eProcurement System

## **eProcurement System Government of India**

## **Tender Details**

Date: 30-Jan-2023 03:40 PM



<b>Basic Details</b>						
Organisation Chain	Indian Institute of Packaging	Indian Institute of Packaging				
Tender Reference Number	IIP/Mumbai/CPPP/2022-23/7002	IP/Mumbai/CPPP/2022-23/7002				
Tender ID	2023_IIP_737550_1	2023_IIP_737550_1				
Tender Type	Open Tender	Form of contract	Works			
Tender Category	Works	No. of Covers	2			
General Technical Evaluation Allowed	No	ItemWise Technical Evaluation Allowed	No			
Payment Mode	Offline	Is Multi Currency Allowed For BOQ	No			
Is Multi Currency Allowed For Fee	No	Allow Two Stage Bidding	No			

	ment Instruments				
Offline	S.No	Instrument Type			
		Demand Draft			

Cover	Cover Details, No. Of Covers - 2			
Cover No	Cover	Document Type	Description	
1	Fee/PreQual/Technical	.pdf	SUPPLY AND FIXING OF PAVER BLOCKS, REPAIRING AND RENOVATION WORKS AT IIP CHENNAI	
2	Finance	.xls	BOQ FOR FINANCIAL BID	

Tender Fee Details, [Total Fee in ₹ * - 1,180]					
Tender Fee in ₹	1,180				
Fee Payable To	Indian Institute of Packaging	Fee Payable At	IIP Mumba		
Tender Fee Exemption Allowed	No				

EMD	EMD Fee Details				
EMD	Amount in ₹	20,000	EMD through BG/ST or EMD Exemption Allowed	Yes	
EMD	<b>Fee Type</b>	fixed	EMD Percentage	NA	
EMD	Payable To	Indian Institute of Packaging	EMD Payable At	IIP Mumbai	

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Work /Item(s)					
Title	SUPPLY AND FIXING OF PAVER BLOCKS, REPAIRING AND RENOVATION WORKS AT IIP CHENNAI				
<b>Work Description</b>	SUPPLY AND FIXING OF PAVER BLOCKS, REPAIRING AND RENOVATION WORKS AT IIP CHENNAI				
Pre Qualification Details	Please refer Tender documents.				
Independent External Monitor/Remarks	NA				
Show Tender Value in Public Domain	No				

Tender Value in E	nment	Product Category	Civil Works	Sub category	NA
Contract Type Sys	Tender Communication	Bid Validity(Days)		Period Of Work (Days)	30
Location	IIP Chennai	Pincode		Pre Bid Meeting Place	IIP Chennai
Pre Bid Meeting Address	Indian Institute of Packaging, Plot no. 169, Industrial Estate, 2nd Main Road, Burma Colony, Perungudi, Chennai - 600096	Pre Bid Meeting Date	15- Feb- 2023 11:00 AM	Bid Opening Place	Mumbai
Should Allow NDA Tender	No	Allow Preferential Bidder	No		

<u>Critical Dates</u>			
Publish Date	30-Jan-2023 04:00 PM	Bid Opening Date	28-Feb-2023 11:00 AM
Document Download / Sale Start Date	30-Jan-2023 05:00 PM	Document Download / Sale End Date	22-Feb-2023 05:00 PM
<b>Clarification Start Date</b>	31-Jan-2023 11:00 AM	Clarification End Date	14-Feb-2023 04:00 PM
<b>Bid Submission Start Date</b>	01-Feb-2023 10:00 AM	Bid Submission End Date	22-Feb-2023 05:00 PM

NIT Document	S.No	Document Name	Description		Document Size (in KB)
	1	Tendernotice_1.pdf		IXING OF PAVER BLOCKS, D RENOVATION WORKS AT IIP	1399.50
Work Item Documents	S.No	Document Type	Document Name	Description	Document Size (in KB)
	1	BOQ	BOQ 775493.xls	BOQ for Financial Bid	264.50

Bid Openers List				
S.No	Bid Opener Login Id	Bid Opener Name	Certificate Name	
1.	itsupport@iip-in.com	Afsha Siddiqui	AFSHA S SIDDIQUI	
2.	iipaccounts3@iip-in.com	Subhash Dalvi	SUBHASH SATWASHIL DALVI	
3.	iipadmin@iip-in.com	Bhushan Surpur	BHUSHAN SHRINIWAS SURPUR	

Tender Properties				
Auto Tendering Process allowed	No	Show Technical bid status	Yes	
Show Finance bid status	Yes	Show Bids Details	Yes	
BoQ Comparative Chart model	Normal	BoQ Compartive chart decimal places	2	
BoQ Comparative Chart Rank Type	L	Form Based BoQ	No	

Tender Inviting Authority		
Name	Assistant Director(IT)	
Address Indian Institute of Packaging, Plot E2, MIDC Area, Andheri East, Mumbai 400093		

Tender Creator Details		

Created By Overn Afsha Siddiqui	
Designation Assistant Director	
Created Date 30-Jan-2023 01:12 PM	
Rivership areas	